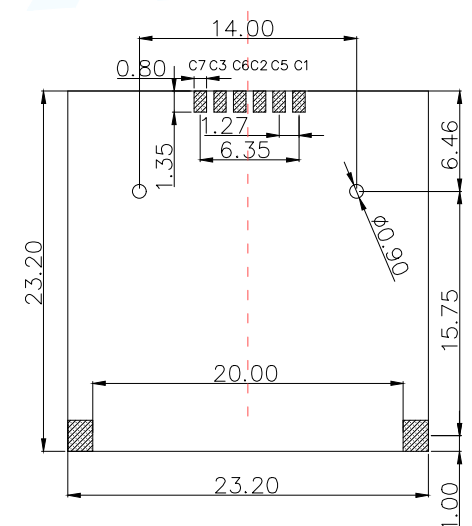
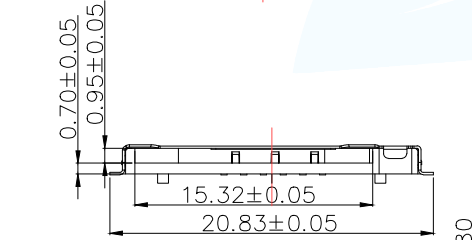
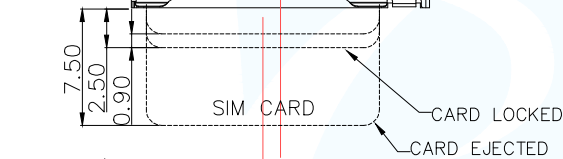
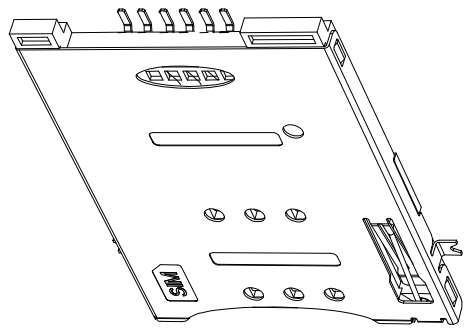


- SPECIFICATIONS**
 INSULATION RESISTANCE: 500M min. AT DC 500V DC
 WITHSTANDING VOLTAGE: 250V ACrms FOR 1 MINUTE
 CONTACT RESISTANCE: 100M max. AT 10MA/20mV max
 CURRENT RATING: 0.5A
 VOLTAGE RATING: 5.0 vrms
 OPERATING TEMP. RANGE: -55℃ ~ + 85℃
 MATING CYCLES: 5000 INSERTIONS
- MATERIAL:**
 INSULATOR: H-TEMPERATURE PLASTIC, UL 94V-0,
 COLOR: BLACK
 TERMINAL: COPPER ALLOY, T=0.15mm
 SHELL: STAINLESS STEEL, T=0.15mm
- FINISH:**
 TERMINAL: 50u" min NICKEL UNDERPLATED ON ALLOVER, GOLD PLATING ON CONTACT AREA, 80u" min TIN ON SOLDER TAIL.
 SHELL: 50u" NICKEL UNDERPLATED ON ALLOVER, GOLD FLASH ON SOLDER LATCH



PAD AREA
 KEEP OUT AREA
 RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE ±0.05

MINI SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A



MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co., Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES		TITLE: MINI SIM CARD PUSH PUSH 6P SMT有柱	
DECIMALS:	ANGLES: ±1°	PAR	SIM-114
X.X: ±0.25		DWN	YAO
X.XX: ±0.10		CHKD	
X.XXX: ±0.05		APVD	
CUSTOMER COPY		SCALE: 1:1	UNIT: MM
		SIZE: A4	SHEET: 1F1
			REV: A